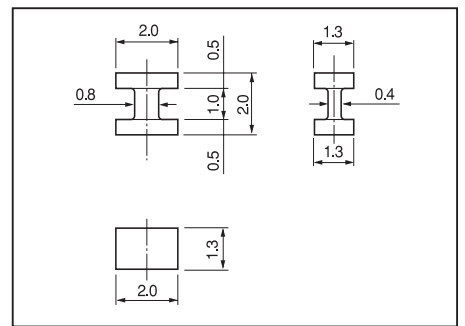
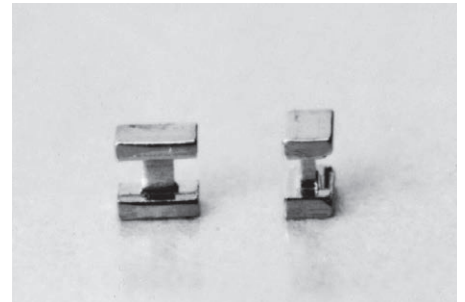


Test point for surface mounting (2 × 1.25 type)

HK-3 series

- This test point is for chip mounter use.
- This can also be used for pattern heat dissipation.
- With the size of 2 × 1.25, this is suitable for small devices.
- This is stored in an embossed tape.
- In the case of reflow with normal cream solder, the strength will be increased by using the land with a simple shape (□) and the size of 2 × 1.3 or over.
- Material: Brass
- Finish HK-3-G: Gold plating over nickel base
HK-3-S: Tin plating over nickel base

Part No.	Package
HK-3-G-T	Reel (1500pcs/reel)
HK-3-G	Bulk (1000pcs/pack)
HK-3-S-T	Reel (1500pcs/reel)
HK-3-S	Bulk (1000pcs/pack)



HK-3- □ -T (tape-and-reel)

■ Recommended land information

